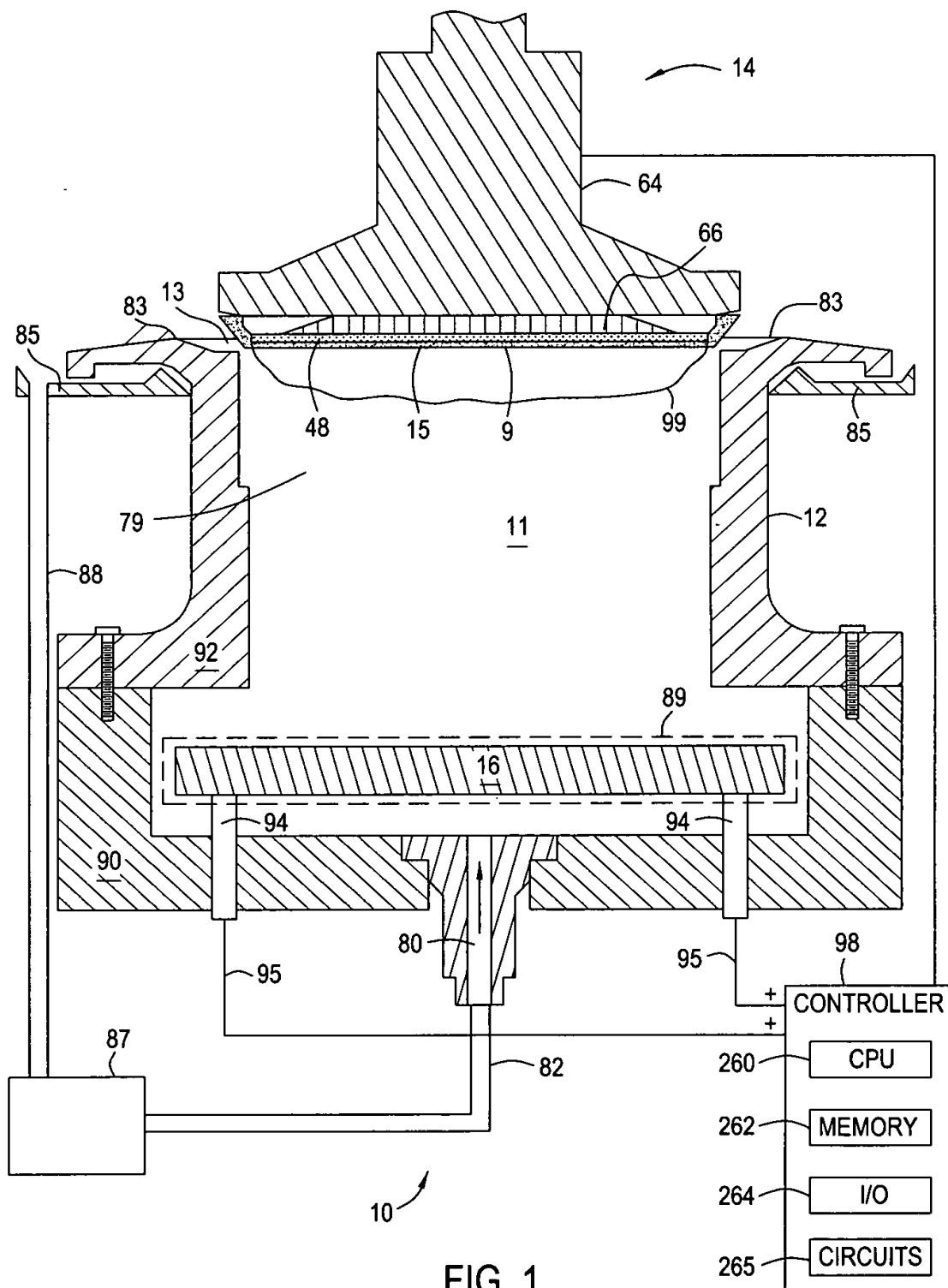




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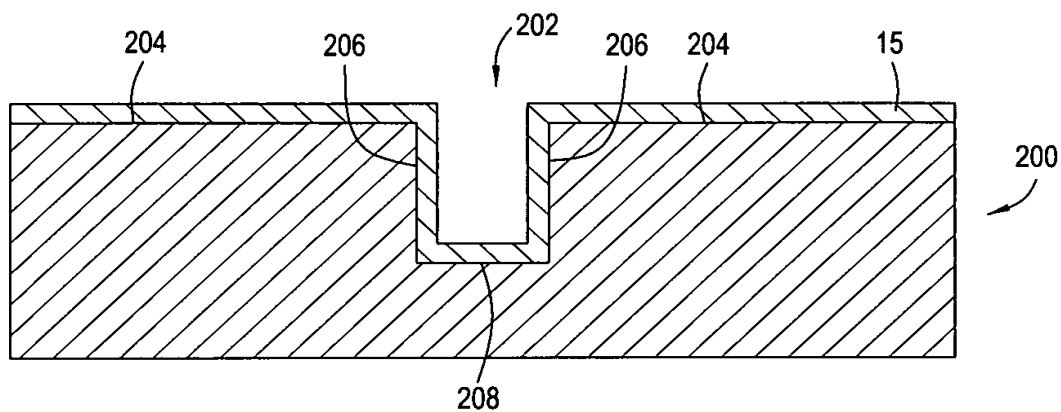


FIG. 2A

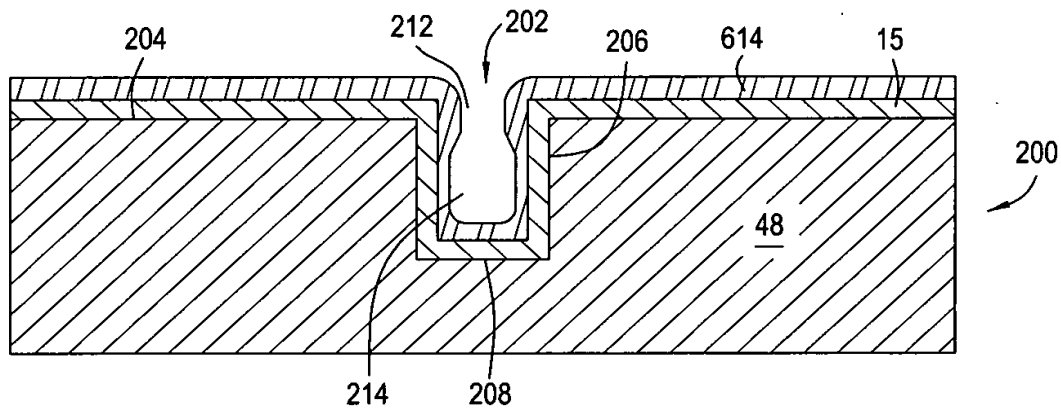


FIG. 2B



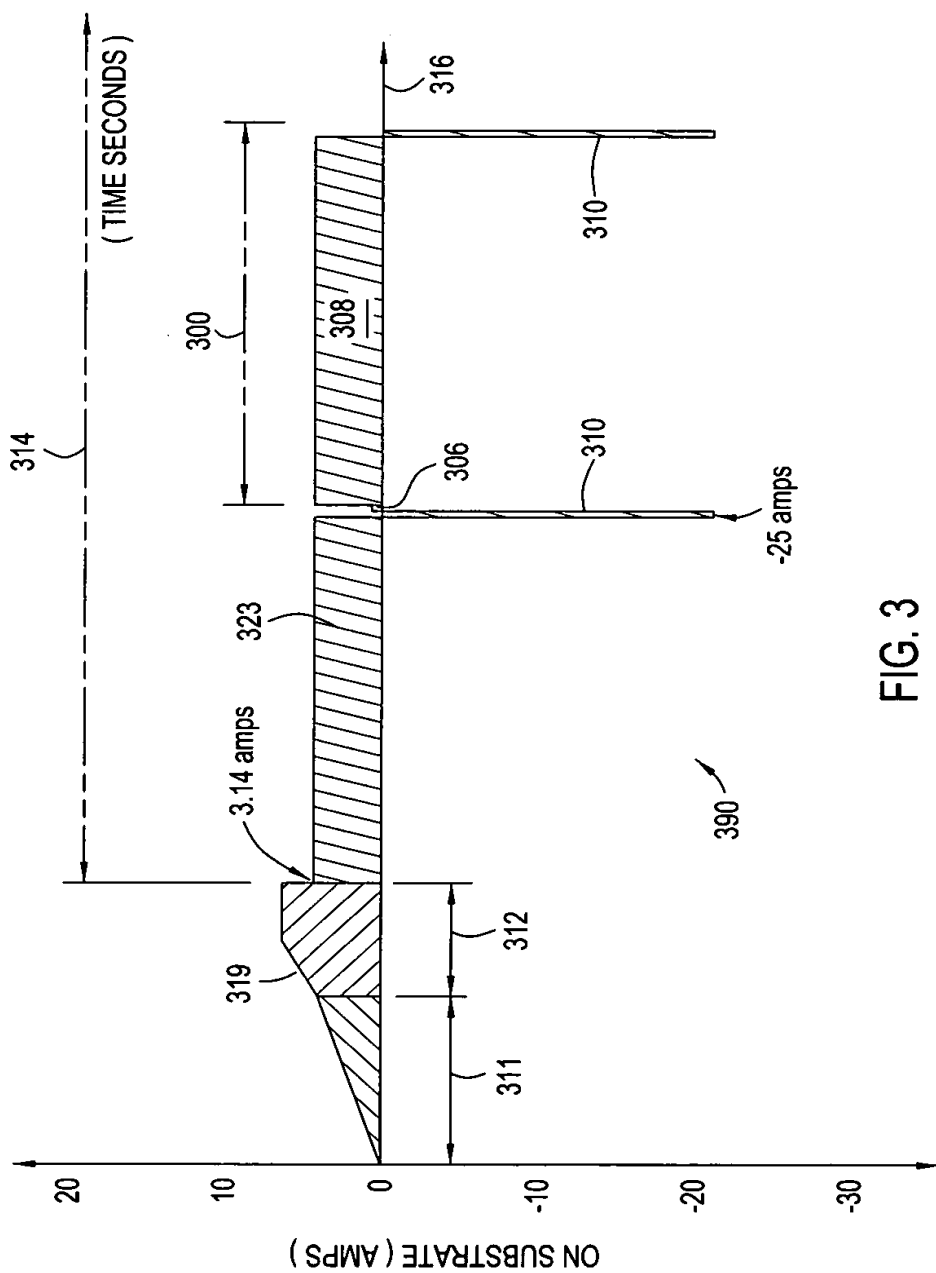
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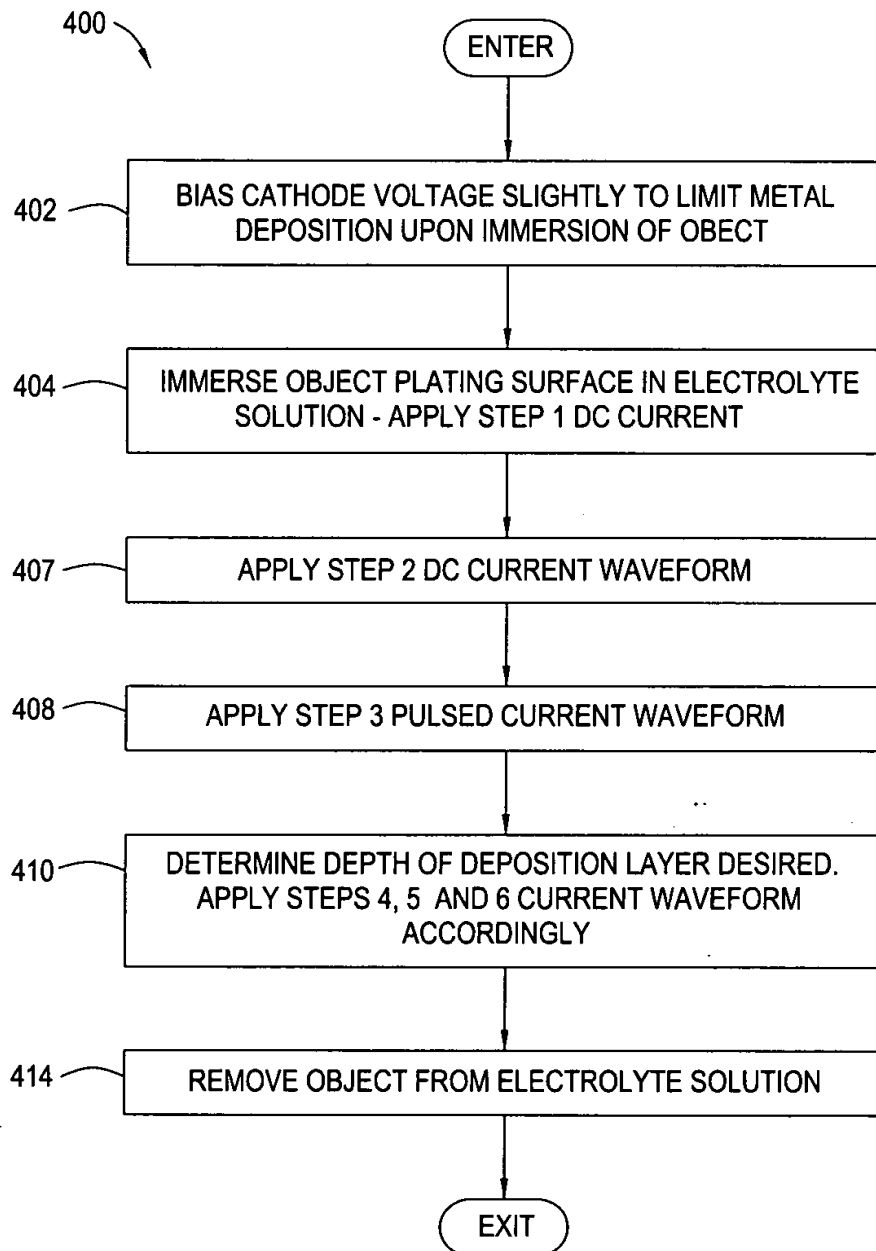
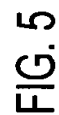


FIG. 4





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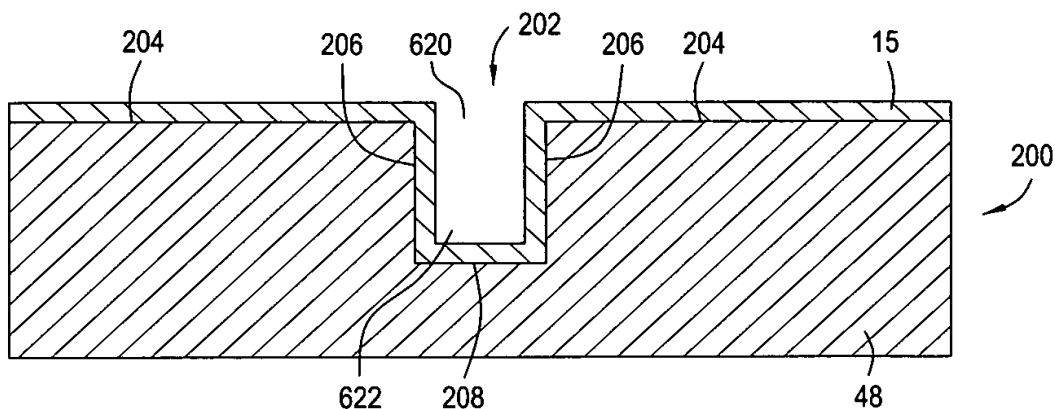


FIG. 6A

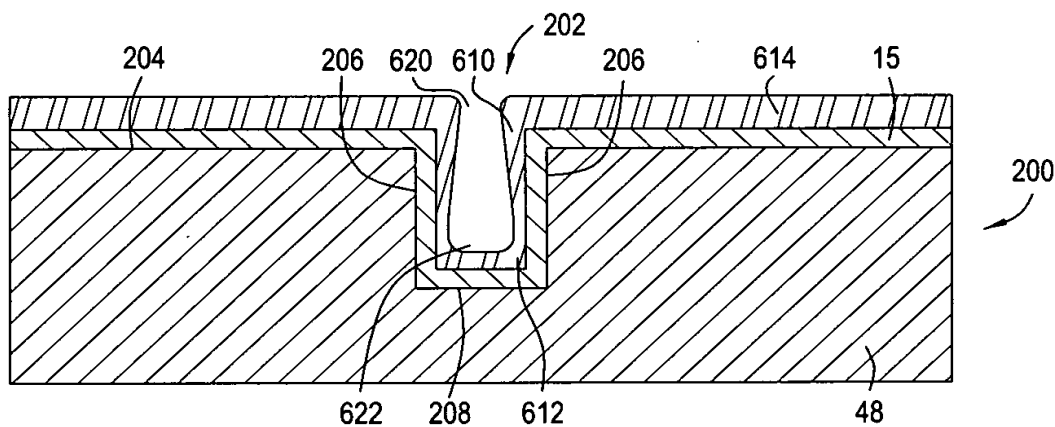


FIG. 6B

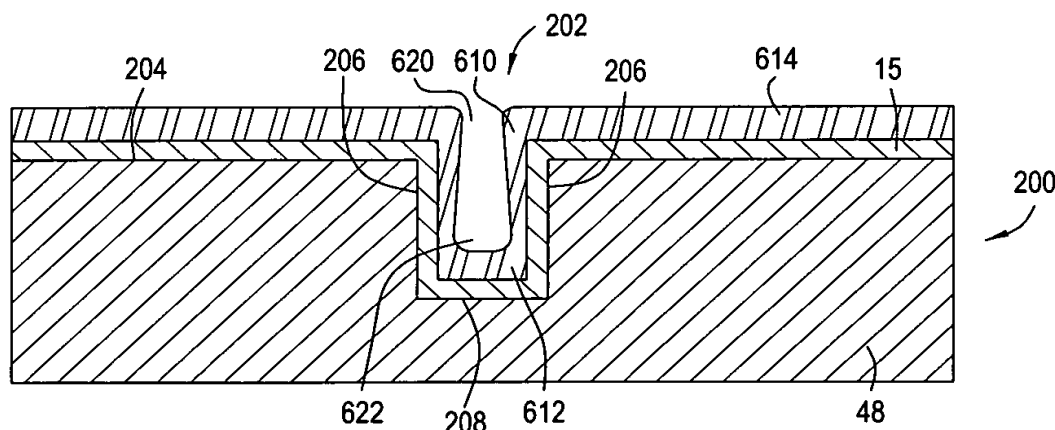
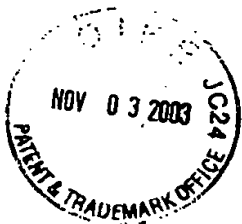


FIG. 6C



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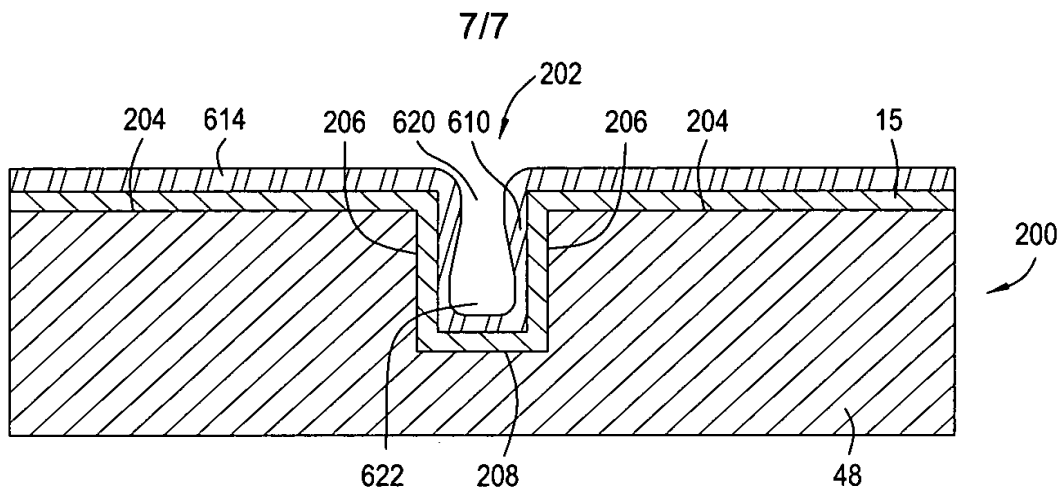


FIG. 6D

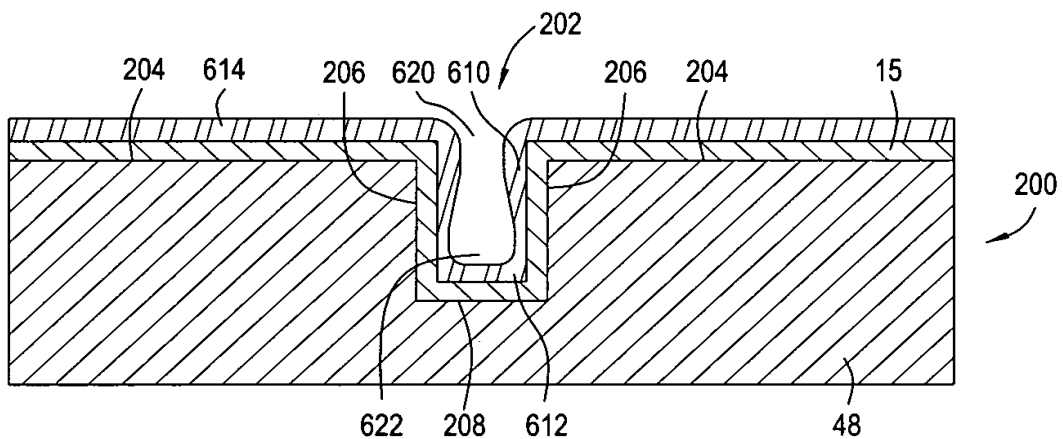


FIG. 6E

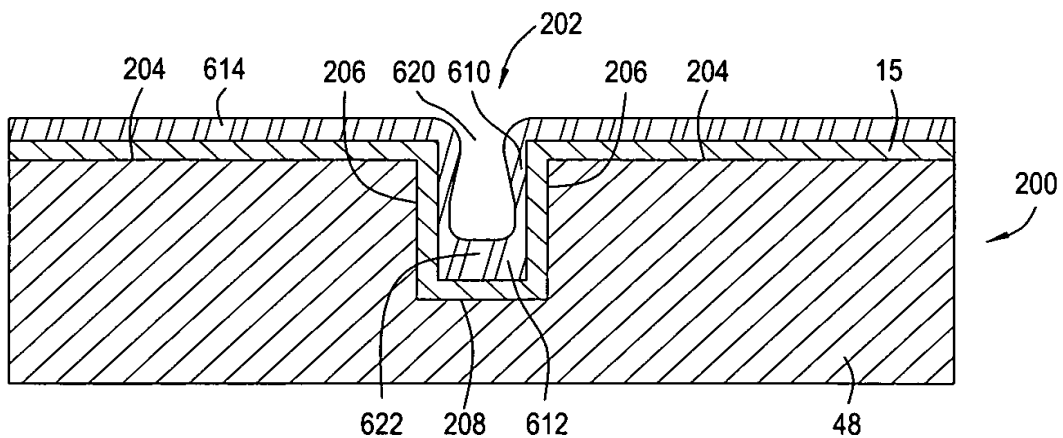


FIG. 6F